Produktbeschreibung

BEST-Lötpaste (Zinnpaste) ist die beste Wahl für Reballing-ICs. Original BEST Marke, Qualität überprüft

Anwendung: kann für laptop / computer / handy / haushaltsgeräte SMD IC und BGA IC reparatur, werkzeuge für chip-ebenereparieren und Elektronikfertigungslinie.

Technologieparameter

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SOLDER PASTE

Lead-free High temperature



500g

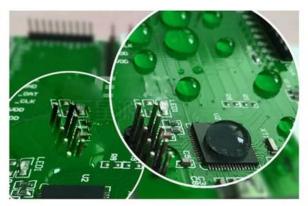
Low residue / Rapid welding / lead free / Solder spot bright /Ag

Product Usage

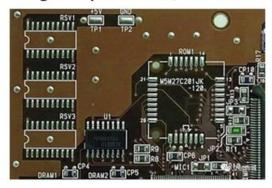


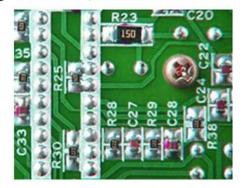
MODEL	BST-705
SHELF LIFE	6 months
INGREDIENT	Sn99/Ag0.3/Cu0.7
WEIGHT	500g
MELTING POINT	217℃

Having a large insulation resistance does not corrode the PCB, and the requirements for no-cleaning can be achieved.



High impedance, full and bright solder, low residue





Welding requirements for a wide range of products





UNIFORM SOLDER JOINT MEDIUM TEMPERATURE MELTING POINT



PRODUCT SIZE



BET Wante Wante Wante Wante Wante Wante Storage of CE

Lead First Wante Wante Wante Wante Wante Storage of CE

Lead First Wante Wante Wante Wante Wante Storage of CE

Lead First Wante Wante Wante Wante Wante Storage of CE

To MM

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52MM

